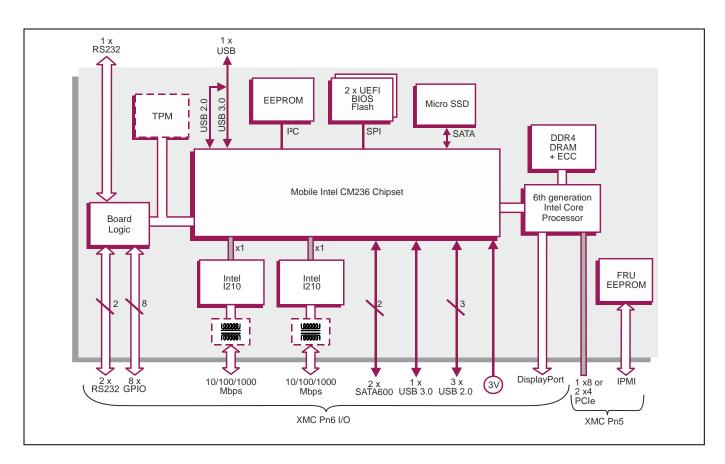
Processor XMC module based on 6th Generation Intel[®] Core[™] Processor

Key Features

XP B5x/msd provides high performance control and management capability for any carrier card with an XMC site. Based on a low power 6th generation Intel[®] Core[™] processor, XP B5x/msd is suitable for rugged and extended temperature operating environments.

- 6th generation Intel Core processor suitable for long life cycle deployments
- Built in Solid State Drive for reliable storage
- Wide range of I/O interfaces available on XMC connectors
- Extended temperature and rugged versions available
- Support for Linux®, Windows® and VxWorks®







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Specification

Processor XMC Module

- utilizes 6th generation Intel[®] Core[™] processor
- XMC Pn6 and Pn5 connectors (build option):
 - → VITA 42 XMC or VITA 61 XMC 2.0
- configurable PCI Express[®] interface via Pn5
- range of I/O interfaces via Pn6
- front panel I/O interface connectors
- rugged conduction-cooled variants available:
 - → see separate XP B5x/msd-RC datasheet

Central Processor

- 2-core Intel® Core™ i3-6102E processor:
 - → 3 Mbytes Cache, 1.90 GHz
 - → Intel® HD Graphics 530
- utilizes the Mobile Intel[®] CM236 Chipset

DRAM

- up to 16 Gbytes soldered DDR4 DRAM:
 - > dual channel architecture
 - → bus speed 2133MHz
- accessible from local processor and base board

XMC Interface

- configurable PCI Express (PCIe®) interface via XMC Pn5 connector supports:
 - → 1 x8 or 2 x4 PCle ports
 - → PCle Gen 1, Gen 2 and Gen 3
- XMC Pn5 connector type (build option) determines the maximum PCle operational speed:
 - → up to Gen 2, VITA 42 connector (color black)
 - → up to Gen 3, VITA 61 connector (color white)
- supports Root Complex operation
- supports IPMI Interface

Gigabit Ethernet Interfaces

- 2 x Gigabit Ethernet interfaces via Pn6:
 - → 10BASE-T, 100BASE-TX, 1000BASE-T
 - → optional on-board magnetics
 - → support for IEEE I588
- implemented by two Intel® Ethernet Controller I210 via x1 PCle ports

Mass Storage Interfaces

- 2 x SATA interfaces via XMC Pn6 connector
- XMC Pn6 connector type (build option) determines the maximum SATA speed:
 - → SATA300, VITA 42 connector (color black)
 - → SATA600, VITA 61 connector (color white)
- 64 Gbytes soldered Micro SSD

Serial Interfaces

- 3 x RS232 serial ports:
 - port 1 supports Tx, Rx, RTS, CTS, DSR, DCD, DTR, RI via Pn6
 - → port 2 supports Tx, Rx, RTS, CTS, DSR, DCD, DTR, via front panel
 - → port 3 supports Tx, Rx, RTS, CTS via Pn6
- 16550 compatible UARTs

Graphics Interface

- DisplayPort[™] interface:
 - → 4096 x 2034 @ 60Hz
- accessible via Pn6
- support for Microsoft® DirectX 11.1 on Windows®
- support for OpenGL 4.4 on Microsoft® Windows® and Linux®

Other Peripheral Interfaces

- watchdog timer, 1 x 32-bit Long Duration Timer
- PC Real-Time Clock (no on-board battery):
 - → VBAT can be supplied via Pn6
- 4 x USB ports via Pn6:
 - → 1 x USB 3.0 port
 - → 3 x USB 2.0 ports
- 1 x USB 3.0/2.0 port via front panel
- 8 x GPIO signals via Pn6:
 - processor interrupt capability

Flash EPROM

dual 16 Mbytes of BIOS Flash EEPROM

Firmware Support

- UEFI boot firmware (BIOS) :
 - → UEFI 2.4 support
 - → EDK II support
 - → includes Compatibility Support Module
- LAN boot firmware included

Software Support

support for Linux[®], Windows[®] and VxWorks[®]

Optional Board Security Packages

- Trusted Platform Module (TPM):
 - → compliant to TCG v1.2

Optional Built-In Test (BIT) Support

 Power-on BIT (PBIT), Initiated BIT (IBIT), Continuous BIT (CBIT)

Electrical Specification

- typical current figure (1.9 GHz, 8 Gbytes DRAM):
 - → +5V @ 3.6A
- +5V VPWR, voltage +5% / -5%
- +12V VPWR is not supported
- supports board power management, under software control

Safety

 PCB (PWB) manufactured with flammability rating of UL94V-0

Environmental Specification

- operating temperatures:
 - → 0°C to +55°C (N-Series)
 - → -25°C to +70°C (E-Series)
 - → -40°C to +85°C (K-Series)
- non-operating temperature: -40°C to +85°C
- 5% to 95% relative humidity, non-condensing:
 - → K-Series includes humidity sealant

Mechanical Specification

- single-width CMC (Common Mezzanine Card)
 IEEE 1386 form factor: (74mm x 149mm)
- 10mm height stack module